| IPC ASSOCIATION ELECTRONICS | © Copyright 2005.             | Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions. |                           | nder both         | This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. |                         |  |          |                    |                                 |                                 |                   |           |  |
|-----------------------------|-------------------------------|---|---------------------------|-------------------|---|-------------------------|--|----------|--------------------|---------------------------------|---------------------------------|-------------------|-----------|--|
| 752-21.1                    |                               | IPC Web Site for Information on IPC-1752 Standard  http://www.ipc.org/IPC-175x  Form Type Distribute  |                           |                   |   |                         |  |          |                    | Materials and                   | ials and Mfg Information        |                   |           |  |
| upplier                     | · Information                 |   |                           |                   |   |                         |  |          |                    |                                 |                                 |                   |           |  |
| Company name*               |                               |   | Company un                | Company unique ID |   |                         | Unique ID Authority                      |          |                    |                                 | Response Date*                  |                   |           |  |
| nsemi                       |                               |   |                           |                   |   |                         |  |          |                    |                                 | 2024-05-02                      |                   |           |  |
| ontact Na                   | ame                           | Title - Conta   | Title - Contact           |                   |   | Phone - Contact*        |  |          |                    | Email - Contact*                |                                 |                   |           |  |
| roduct-E                    | Env-Stewards                  |   | Product Enviro Compliance |                   |   |                         | NA                                       |          |                    |                                 | Product-Env-Stewards@onsemi.com |                   |           |  |
| uthorized                   | d Representative*             | Title - Representative  |                           |                   | I   | Phone - Representative* |  |          | Email              | Email - Representative*         |                                 |                   |           |  |
| roduct-E                    | Env-Stewards                  | Product Env   | Product Enviro Compliance |                   |   | NA                      |  |          |                    | Product-Env-Stewards@onsemi.com |                                 |                   |           |  |
|                             | Requester Item Number Mfr     |   | em Number Mfr Item Name   |                   |   |                         | Effective Date                           | Version  | Manufacturing Site |                                 | Weight*                         | UOM               | Unit Type |  |
|                             |                               | SB580 5A 80V SCHOTTE  |                           | KY RECTI          |   | 2024-05-02              |  | PANJITFG |                    | 1122.0182                       | mg                              | Each              |           |  |
|                             | cturing Process Informa       |   | T1 D                      | A11               | CTD 020 MG  | I. Dating               | Deale Duces                              | D. J. T. | Mar Time           | Deale Terror                    | N                               | and Deflect Court |           |  |
|                             | 8                             |   |                           |                   | -STD-020 MSI  | L Rating                | Peak Process Body Temperature Max Time a |          | 1.                 | <u> </u>                        |                                 |                   |           |  |
|                             | Matte Tin (Sn) - annealed     |   | CU Alloy                  | Γ                 | NA  |                         | 0  | <u> </u> | 30                 | sec                             | onds 3                          |                   |           |  |
| omments                     |                               |   |                           |                   |   |                         |  |          |                    |                                 |                                 |                   |           |  |
|                             | information regarding materia |   |                           |                   |   |                         |  |          |                    |                                 |                                 |                   |           |  |

| RoHS Material Composition Declaration   |  |   | Declaration Type *                              | Detailed                                     |  |  |  |  |  |  |
|---|--|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).  |  |   |   |  |  |  |  |  |  |  |
| Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its keloardine shall encompass all such components. Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier shall applier of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. |  |   |   |  |  |  |  |  |  |  |
| RoHS Declaration * 4 - Item(s   | ) does not contain RoHS restricted substance | es per the definition above except for selected exemp | otions Supplier Acceptance                      | * Accepted                                   |  |  |  |  |  |  |
| Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).   |  |   |   |  |  |  |  |  |  |  |
| Exemption List Version  | EL-2011/534/EU                               |   |   |  |  |  |  |  |  |  |
| Declaration Signature   |  |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required f<br>Requester) and click on Submit Form to ha   |  | 'Accepted" on the Supplier Acceptance drop-dow        | n. This will display the signature area. Digita | lly sign the declaration (if required by the |  |  |  |  |  |  |
| Supplier Digital Signature Ra   | astislav Drska                               | -6_   |   |  |  |  |  |  |  |  |

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

| Homogeneous Material | Weight   | Unit of Measure | Level    | Substance   | CAS         | Exempt | Weight   | Unit of Measure |
|----------------------|----------|-----------------|----------|---|-------------|--------|----------|-----------------|
| Die                  | 3.78     | mg              | Supplier | Silicon (Si)  | 7440-21-3   |        | 3.78     | mg              |
| Die Attach Solder    | 4.1195   | mg              | Supplier | Silver (Ag)   | 7440-22-4   |        | 0.103    | mg              |
|                      |          |                 | A        | Lead (Pb)   | 7439-92-1   | 7a     | 3.8105   | mg              |
|                      |          |                 | Supplier | Tin (Sn)  | 7440-31-5   |        | 0.206    | mg              |
| Lead Wire            | 820.9194 | mg              | Supplier | Iron (Fe)   | 7439-89-6   |        | 0.6569   | mg              |
|                      |          |                 | Supplier | Copper (Cu)   | 7440-50-8   |        | 820.0984 | mg              |
|                      |          |                 | Supplier | Phosphorus (P)  | 7723-14-0   |        | 0.164    | mg              |
| Marking Ink          | 0.0231   | mg              | Supplier | Silicon Dioxide (SiO2)  | 112945-52-5 |        | 0.0012   | mg              |
|                      |          |                 | Supplier | 1-Hydroxycyclohexyl phenyl ketone                               | 947-19-3    |        | 0.0012   | mg              |
|                      |          |                 | Supplier | Padimate (C14H21NO2)  | 21245-01-2  |        | 0.0023   | mg              |
|                      |          |                 | Supplier | 2-Propenoic acid polymer  | 53192-18-0  |        | 0.015    | mg              |
|                      |          |                 | Supplier | Aluminum (Al)   | 7429-90-5   |        | 0.0035   | mg              |
| Mold Compound-Black  | 233.9    | mg              | Supplier | 2,6-dibromo-4-[1-(3-bromo-4-hydroxyphenyl)-1-methylethyl]phenol | 6386-73-8   |        | 4.6774   | mg              |
|                      |          |                 | Supplier | Ortho Cresol Novolac Resin                                      | 29690-82-2  |        | 58.4352  | mg              |
|                      |          |                 | В        | Antimony Trioxide (Sb2O3)                                       | 1309-64-4   |        | 4.6774   | mg              |
|                      |          |                 | Supplier | Carbon Black (C)  | 1333-86-4   |        | 2.3387   | mg              |
|                      |          |                 | Supplier | Fused Silica (SiO2)   | 60676-86-0  |        | 163.7713 | mg              |
| Plating              | 59.2762  | mg              | Supplier | Tin (Sn)  | 7440-31-5   |        | 59.2762  | mg              |